

L Number	Hits	Search Text	DE	Time stamp
1	1372	"insulated wire" with coating	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 09:37
2	2	("insulated wire" with coating) and (438/\$).CCLS.	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 09:39
3	3	4,360,433.pn.	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 09:39
4	433	wire with method with coating with insulating	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 09:40
5	59	(wire with method with coating with insulating) and semiconductor	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 09:45
6	337	copper adj oxide with insulating	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 10:23
7	2	6034195.pn.	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 11:12
8	2	6091381.pn.	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 11:13
9	2	("5530292"   "5545922"   "5793108"   "5817242"   "5952725"   "5959347"   "6021733").PN.	USPAT	2002/06/18 11:12
10	1334	(257/723).CCLS.	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 11:13
11	168	((257/723).CCLS.) and wire adj bond	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 11:18
14	11	("4862245"   "5012323"   "5101324"   "5191061"   "5438224"   "5463253"   "5471366"   "5479051"   "5523608"   "5539150"   "5579208"   "5689135").PN.	USPAT	2002/06/18 11:17
15	420	(257/782).CCLS.	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 11:19
16	7	((257/782).CCLS.) and chip with stacked	USPAT; US-PGPUR; EPO; JPO; DEFWENT; IBM_TDB	2002/06/18 11:20

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65 "insulated wire" and (257/\$).ccls.

USPAT;  
US-PGPUB;  
EPO; JPO;  
DERWENT;  
IEM\_TDB

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